

Alpha and Omega Semiconductor Statement on RoHS 2.0 Recast in 2016

Following is the statement from Alpha and Omega Semiconductor (hereinafter referred to as AOS) regarding Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of hazardous substances in electrical and electronic equipment (RoHS Recast).

AOS is aware that the RoHS exemptions that currently apply to some of our products are set to expire on July 21, 2016.

We are actively engaged in testing and qualifying viable alternatives to replace the exempted materials currently used in these affected products. The material currently use under.

Exemption 7(a) – lead in high melting temperature type solders (i.e. lead based alloys containing 85% by weight or more lead).

Exemption 15 – Lead in solders to complete a viable electrical connection between semiconductor die and carrier within integrated circuit Flip Chip packages.

AOS has been working diligently on possible solutions, but none exist today for the majority of these products.

In the event that alternative materials cannot be identified and qualified as suitable replacements for materials currently using exemption 7(a) and 15, AOS will, by February 1st 2015, prepare and submit an application for renewing exemptions as defined in Article 5 and Annex V of the RoHS Recast.